



E-cloud in Devices with Common Chamber: Inner Triplets and TDIS

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Many thanks to:

C. Bracco, R. De Maria, L. Gentini, G. Mazzacano, A. Perillo-Marcone, A. Romano, G. Rumolo, M. Taborelli



Outline

- Simulation setup
- e-cloud in inner triplets at IR1&5 and IR2&8
 - heat load estimates with and without coating
 - e-cloud in dipole, quadrupole and drift
- e-cloud in TDIS:
 - heat loads along the device
 - heat loads for different gaps



e-cloud simulations in triplets

E-cloud is simulated in main magnets, in dipole correctors and in the drifts

- With uniform SEY
- With non-uniform SEY: the drifts outside cold masses are uncoated

Main simulation parameters

- Beam parameters: 7 TeV, 2.2e11 p/bunch, 25 ns bunch spacing
- HL-LHC v1.2 optics
- Two counter-rotating beams: simulate different slices along triplet to account for arrival times, beam sizes and position of each beam
- SEY scan: 1.0 1.6
- Uncoated drifts simulated with SEY = 1.3





Heat load in IR1&5: uniform SEY



- If the whole inner triplet IR1&5 uncoated (SEY 1.3) heat load is an order of magnitude higher than in fully-coated case (SEY 1.1)
- Maximum heat load at locations between long-range encounters (beams not synchronized)



Heat load in IR1&5: uncoated drifts



- If only the drifts outside cold masses are uncoated (SEY 1.3) and the rest of the region is coated (SEY 1.1) heat load is reduced from 1600 W to 311 W
- Contribution to the total heat load from uncoated drifts is 265 W



Heat load in IR2&8: uniform SEY



- If the whole inner triplet IR2&8 uncoated (SEY 1.3) heat load is more than one order of magnitude higher than in fully-coated case (SEY 1.1)
- Maximum heat load at the locations between long-range encounters (beams not synchronized)



Heat load in IR2&8 : uncoated drifts



- If only the drifts outside cold masses are uncoated (SEY 1.3) and the rest of the region is (SEY 1.1) heat load is reduced from 950 W to 34 W
- Contribution to the total heat load from uncoated drifts is 31 W



e-cloud in a IR8 quadrupole magnet



- Heat load at different longitudinal positions along the quadrupole (different delay): highest heat load at the position in between two long range encounters
- Electron distribution is mainly concentrated along the pole-to-pole lines
- Some electrons are trapped along the field lines



e-cloud in a IR8 dipole magnet



- Heat load at different longitudinal positions along the dipole (different delay): highest heat load at the position in between two long range encounters
- Electrons are located along the field lines



e-cloud in a IR8 drift



- Heat load at different longitudinal positions along the dipole (different delay): highest heat load at the position in between two long range encounters
- Electrons in the chamber get the kick from the passing beams and impact the walls



Total heat loads: IR1&5 vs IR2&8



Heat load in IR1&5 is much higher than in IR2&8

 In case of fully coated inner triplets (from SEY 1.3 to SEY 1.1) heat load can be reduced by order of magnitude



e-cloud simulations in TDIS

We performed a first series of simulations to identify possible critical points:

- Assumed uniform SEY for the whole profile
- SEY=1.4-1.5 (Cu-like) can be considered as a worst case scenario
- We assume that no high SEY surfaces (e.g. aluminum) are exposed to the beam

Main simulation parameters

- Beam parameters: 450 GeV, 2.2e11 p/bunch, 25 ns bunch spacing
- HL-LHC v1.2 optics
- Two counter-rotating beams: simulate different slices along TDIS to account for arrival times, beam sizes and position of each beam
- Half-gap scan: 1 50 mm
- SEY scan: 1.0 1.6







Multipacting is stronger at the positions where the two beams are not synchronized (12.5 ns equivalent spacing)





Multipacting is stronger at the positions where the two beams are not synchronized (12.5 ns equivalent spacing)





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TDIS: electron flux on the different surfaces



 At large gaps e-cloud starts to buildup on the surface of the jaws and on the flat parts of the beam screen



TDIS: total electron flux

- Electron flux on the walls increases for large gaps
- Multipacting threshold very high for small gaps and decreasing when the jaws are opened
- Situation tends to saturate for half-gaps larger than 40 mm





TDIS: heat deposition from the e-cloud

 Even for the worst half-gap (50 mm) and for high SEY the heat load on the whole device does not reach 250 W





Summary

We simulated the e-cloud in the presence of both beams in the Inner triplet and TDIS assuming:

- SEY scan: 1.0-1.6. Uncoated drifts in inner triplets
- Uniform SEY scan: 1.0-1.6. Gap scan in TDIS

In Inner Triplets:

- Heat load is more than an order of magnitude higher for the uncoated case (SEY 1.3) than for the fully coated (SEY 1.1)
 - IR1&5: reduced from 1633 W t o169 W
 - IR2&8: reduced from 943 W to 23W
- If only drifts outside cold masses are uncoated (SEY 1.3):
 - IR1&5 heat load is 311 W where 265 W is the contribution of the uncoated drifts
 - IR2&8 heat load is 34 W where 30 W is the contribution of the uncoated drifts
- Heat load in IR1&8 is much higher than in IR 2&8

In TDIS:

- Electron flux on the walls increases for large gaps:
 - e-cloud builds up mainly from the surface of the jaws and on the flat parts of the beam screen
 - Multipacting threshold very high for small gaps and decreasing when the jaws are opened
 - Electron flux and heat-load tend to saturate for half-gaps larger than 40 mm
- Heat load from e-cloud on the whole device does not reach 250 W even for large gaps

